

PATENT

Docket No.: ACT-233

Coppose THE UNITED STATES PATENT AND TRADEMARK OFF

rt Unit: 2825

Examiner: A.M. Thomson

Serial No. 09/069,054

Filed: April 28, 1998

In re Application of: Chan et al.

DEDICATED INTERFACE ARCHITECTURE FOR A HYBRID INTEGRATED

CIRCUIT

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RESPONSE TO OFFICE ACTION

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Director of Patents Box DAC Washington, D.C. 20231

Dear Sir:

In response to the Office Action dated September 7, 2000, kindly amend the above-identified application as follows.

In the Drawings

Submitted herewith for the Examiner's approval are proposed amendments to drawing FIGS. 1A-1F, 2 and 3. The proposed amendments to the drawing figures are indicated thereon in red ink.

The 35 U.S.C. § 102 Rejection

Claims 1-3, 7-9, and 11-19 stand rejected under 35 U.S.C. § 102(b) as being allegedly anticipated by Tavana et al. (U.S. Patent No. 5,825,202, hereinafter "202"). This rejection is respectfully traversed.

The Examiner asserts that '202 discloses an integrated circuit with Field